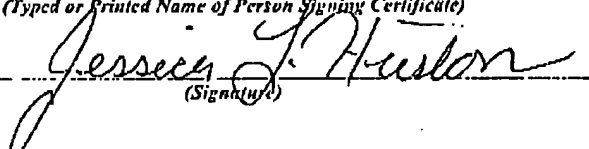


NOV 03 2005

CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)			Docket No. FIS920030398US1	
Applicant(s): ROGER LAM ET AL.				
Application No. 10/708,066	Filing Date 02/06/2004	Examiner B. CHERVINSKY	Group Art Unit 2835	
Invention: METHOD AND STRUCTURE FOR HEAT SINK ATTACHMENT IN SEMICONDUCTOR DEVICE PACKAGING				
<p>I hereby certify that this <u>Notice of Appeal and Pre-Appeal Brief Request for Review</u> (Identify type of correspondence)</p> <p>is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. 571-273-8300)</p> <p>on <u>11/03/2005</u> (Date)</p> <p style="text-align: right;">Jessica L. Huston (Typed or Printed Name of Person Signing Certificate)  (Signature)</p> <p style="text-align: center;">Note: Each paper must have its own certificate of mailing.</p> <p style="text-align: right;">RECEIVED OIPE/IAP NOV 04 2005</p>				